



T.L. Ritzdorf et al. Applicants:

Attorney Docket No.: SEMT116049

Application No.: 09/018,783

Group Art Unit: 2823

Filed:

February 4, 1998

Examiner: D.M. Collins

Title:

METHOD FOR FILLING RECESSED MICRO-STRUCTURES WITH METALLIZATION IN THE PRODUCTION OF A MICROELECTRONIC

DEVICE

ASSOCIATE POWER OF ATTORNEY AND CHANGE OF CORRESPONDENCE ADDRESS

Seattle, Washington 98101 June 18, 2001

TO THE DIRECTOR – U.S. PATENT AND TRADEMARK OFFICE:

Paul Parker, Reg. No. 38,264, and Robert W. Polit, Reg. No. 33,993, are hereby granted an associate power of attorney with full power to prosecute the above-identified application and to transact all business in the United States Patent and Trademark Office connected therewith.

Please address all further correspondence relating to this application to:

Paul Parker, Esq. PERKINS COIE LLP

1201 Third Avenue, Suite 4800 Seattle, WA 98101-3099

Telephone: (206) 583-8888 Facsimile: (206) 583-8500

2800 MAIL ROOM

Respectfully submitted,

CHRISTENSEN O'CONNOR JOHNSON KINDNESSPLLC

Marcia S. Kelbon

Registration No. 34,358

Direct Dial No. 206.695.1720

I hereby certify that this correspondence is being deposited with the U.S. Postal Service in a sealed envelope as first class mail with postage thereon fully prepaid and addressed to the Commissioner for Patents, Washington, D.C. 20231, on the below date.

June 18, 2001 Date:

MSK:mc

LAW OFFICES OF CHRISTENSEN O'CONNOR JOHNSON KINDNESSPILE 1420 Fifth Avenue **Suite 2800** Seattle, Washington 98101 206.682.8100